

# 2.2A, 400V - 1000V Standard Bridge Rectifier

#### **FEATURES**

- Glass passivated chip junction
- Ideal for automated placement
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326854
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

#### **MECHANICAL DATA**

· Case: YBS

• Molding compound meets UL 94V-0 flammability rating

• Matte tin plated leads, solderable per J-STD-002

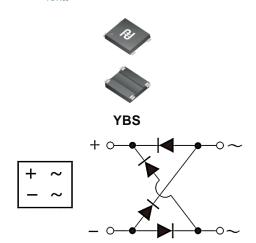
• Meet JESD 201 class 1A whisker test

Polarity: As marked

• Weight: 0.220g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE UNIT		
I <sub>F</sub>	2.2	Α	
$V_{RRM}$	400 - 1000	V	
I <sub>FSM</sub>	90	Α	
$T_{JMAX}$	150	°C	
Package	YBS		
Configuration	Quad		





ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER	SYMBOL	YBS 2204G	YBS 2205G	YBS 2206G	YBS 2207G	UNIT
Marking code on the device		YBS2204G	YBS2205G	YBS2206G	YBS2207G	
Repetitive peak reverse voltage	$V_{RRM}$	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	280	420	560	700	V
Forward current	I <sub>F</sub>	= 2.2		Α		
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	90		А		
Rating for fusing (t<8.3ms)	l <sup>2</sup> t	t 33.61		A <sup>2</sup> s		
Junction temperature	TJ	T <sub>J</sub> -55 to +150		°C		
Storage temperature	T <sub>STG</sub>	-55 to +150			°C	

1



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	R <sub>eJL</sub>	24	°C/W
Junction-to-ambient thermal resistance	R <sub>OJA</sub>	61	°C/W
Junction-to-case thermal resistance	R <sub>eJC</sub>	11	°C/W

**Thermal Performance Note:** Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode <sup>(1)</sup>	$I_F = 1.1A, T_J = 25^{\circ}C$	V <sub>F</sub>	0.86	0.92	V
	I <sub>F</sub> = 2.2A, T <sub>J</sub> = 25°C		0.91	0.97	V
	I <sub>F</sub> = 1.1A, T <sub>J</sub> = 125°C		0.73	0.90	V
	I <sub>F</sub> = 2.2A, T <sub>J</sub> = 125°C		0.78	0.95	V
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>	T <sub>J</sub> = 25°C	l <sub>R</sub>	-	5	μA
	T <sub>J</sub> = 125°C		-	100	μA
Junction capacitance per diode	1MHz, $V_R = 4.0V$	CJ	70	90	pF
Reverse recovery time	$I_F = 0.5A, I_R = 1.0A$ $I_{rr} = 0.25A$	t <sub>rr</sub>	2400	4000	ns

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE	PACKAGE	PACKING
YBS22xG	YBS	3,000 / Tape & Reel

#### Notes:

1. "x" defines voltage from 400V(YBS2204G) to 1000V(YBS2207G)



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Forward Current Derating Curve

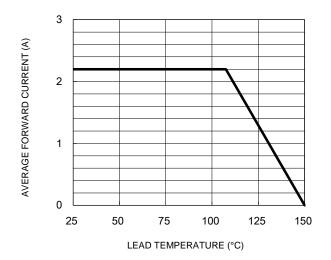


Fig.2 Typical Junction Capacitance

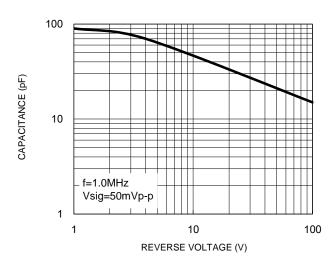


Fig.3 Typical Reverse Characteristics

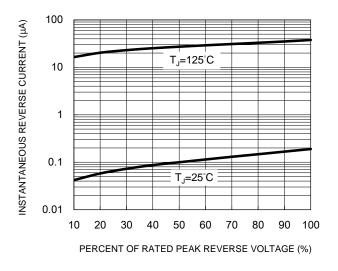
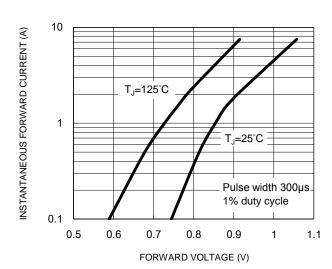
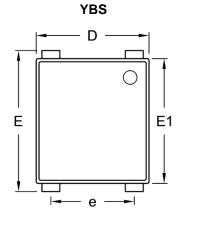


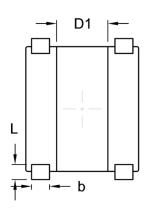
Fig.4 Typical Forward Characteristics

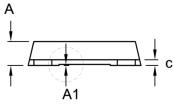


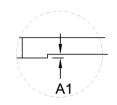


## **PACKAGE OUTLINE DIMENSIONS**



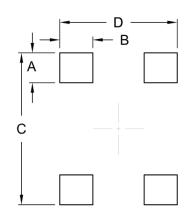






DIM.	Unit (mm)		Unit (	(inch)	
DIW.	Min.	Max.	Min.	Max.	
Α	1.30	1.50	0.051	0.059	
A1	0.04	0.08	0.002	0.003	
b	0.95	1.15	0.037	0.045	
С	0.27	0.40	0.011	0.016	
D	6.50	6.70	0.256	0.264	
D1	2.90	3.10	0.114	0.122	
E	7.90	8.60	0.311	0.339	
E1	7.20	7.40	0.283	0.291	
е	5.00	5.20	0.197	0.205	
L	0.70	1.05	0.028	0.041	

## **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	1.80	0.070
В	2.00	0.078
С	9.15	0.360
D	7.10	0.279

## **MARKING DIAGRAM**



P/N = Marking Code

YW = Date Code

F = Factory Code



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